

Logic level N-Channel MOSFET in MLPAK56-WF (SOT8038-2) 15 January 2025 Product data sheet

1. General description

Logic level N-Channel MOSFET in a small MLPAK56-WF (SOT8038-2) package, using Trench 9 technology. This product has been designed and qualified to meet AEC-Q101 requirements delivering high performance and reliability.

2. Features and benefits

- Trench 9 technology
- Low R_{DS(on)} to minimize conduction losses
- Small footprint (5 x 6 mm) for compact design
- Qualified to AEC-Q101 at 175 °C
- Side-wettable flanks for robust solder joints and automated optical inspection

3. Applications

- Motor drive
- Battery protection
- DC-DC conversion

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit	
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C		-	-	40	V	
I _D	drain current	V _{GS} = 10 V; T _{mb} = 25 °C; <u>Fig. 2</u>		-	-	91	А	
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>		-	-	71	W	
Static chara	Static characteristics							
R _{DSon}	drain-source on-state resistance	V _{GS} = 10 V; I _D = 25 A; T _j = 25 °C; Fig. 11		2.7	3.8	4.5	mΩ	
Dynamic characteristics								
Q _{GD}	gate-drain charge	$ I_D = 25 \text{ A}; V_{DS} = 20 \text{ V}; V_{GS} = 4.5 \text{ V}; \\ T_j = 25 \text{ °C}; \underline{Fig. 13}; \underline{Fig. 14} $		-	3.7	7.4	nC	

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5. Pinning information

Table 2. Pinning information							
Pin	Symbol	Description	Simplified outline	Graphic symbol			
1	S	source	8765 2727				
2	S	source					
3	S	source		D			
4	G	gate					
5	D	drain	T	G-UFA			
6	D	drain		mbb076 S			
7	D	drain					
8	D	drain	MLPAK56-WF (SOT8038-2)				

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BXK9R4R5-40H	MLPAK56-WF	MLPAK56-WF: 8 terminals; body 5.15 x 6.2 x 1.0 mm	SOT8038-2

7. Marking

Table 4. Marking codes					
Type number	Marking code				
BXK9R4R5-40H	94H540R				

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Tj = 25 °C unless otherwise stated.

Symbol	Parameter	Conditions		Min	Мах	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C		-	40	V
V _{GS}	gate-source voltage			-20	20	V
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>		-	71	W
I _D	drain current	V _{GS} = 10 V; T _{mb} = 25 °C; <u>Fig. 2</u>		-	91	А
		V _{GS} = 10 V; T _{mb} = 100 °C		-	64	А
I _{DM}	peak drain current	pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^{\circ}C$; Fig. 3		-	363	А
T _{stg}	storage temperature			-55	175	°C
Tj	junction temperature			-55	175	°C
Source-drai	n diode	1				
Is	source current	T _{mb} = 25 °C		-	59	А
I _{SM}	peak source current	pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^{\circ}C$		-	363	А
Avalanche r	uggedness	1		1		
E _{DS(AL)S}	non-repetitive drain- source avalanche energy	I_D = 80 A; $V_{sup} \le 40$ V; R_{GS} = 50 Ω; V_{GS} = 10 V; $T_{j(init)}$ = 25 °C; unclamped	[1] [2] [3]	-	58	mJ

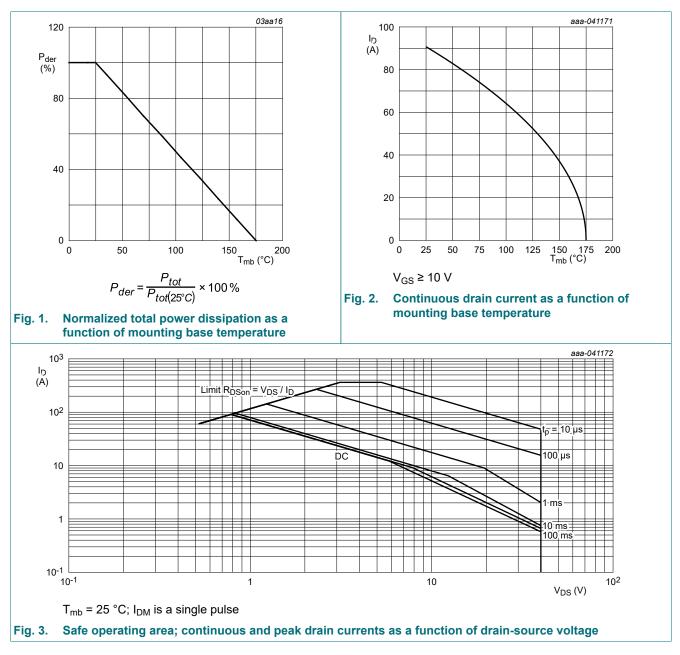
Logic level N-Channel MOSFET in MLPAK56-WF (SOT8038-2)

Symbol	Parameter	Conditions		Min	Max	Unit
I _{AS}	non-repetitive avalanche current	$V_{sup} \le 40 \text{ V}; V_{GS} = 10 \text{ V}; T_{j(init)} = 25 \text{ °C}; R_{GS} = 50 \Omega; Fig. 4$	[3]	-	80	A

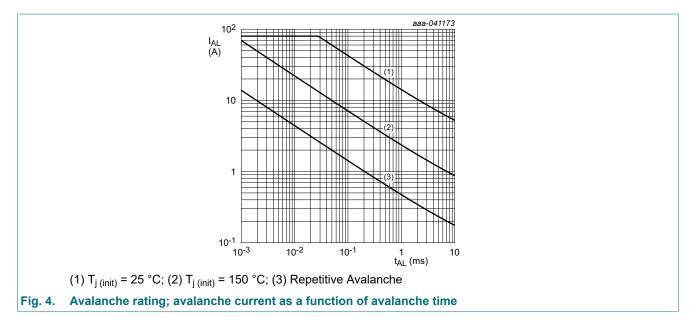
Single-pulse avalanche rating limited by maximum junction temperature of 175 °C. [1]

Refer to application note AN10273 for further information.

[2] [3] Protected by 100% test.



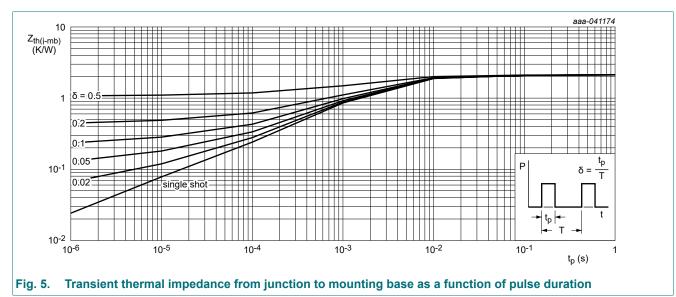
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9. Thermal characteristics

Table 6. Thermal characteristics								
Symbol	Parameter	Conditions		Min	Тур	Max	Unit	
R _{th(j-mb)}	thermal resistance from junction to mounting base	Fig. <u>5</u>		-	1.77	2.12	K/W	
R _{th(j-a)}	thermal resistance from junction to ambient		[1]	-	25	-	K/W	

[1] Device on 4 layer PCB. Refer to TN00008 for further information.



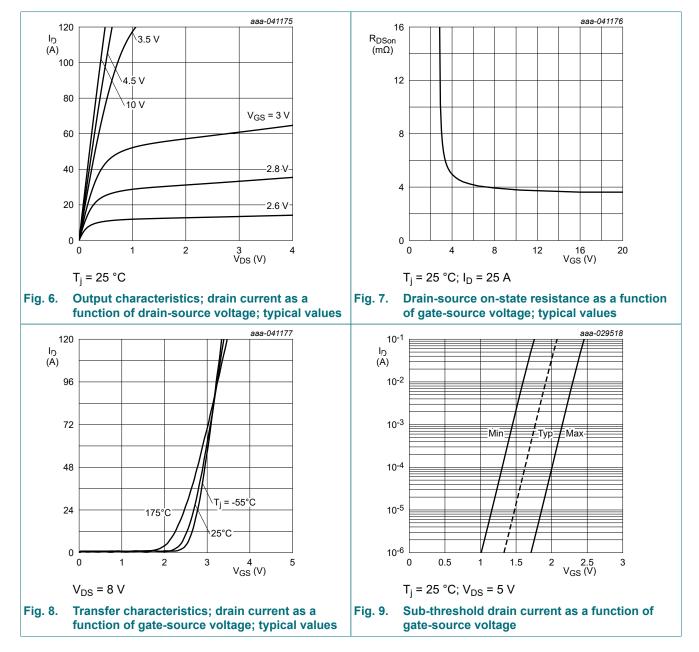
10. Characteristics

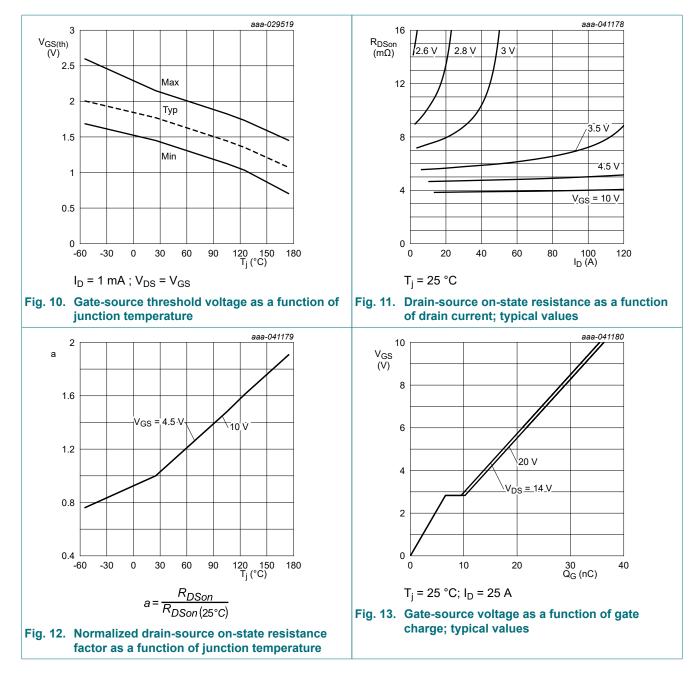
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	acteristics					
V _{(BR)DSS}	drain-source	I _D = 250 μA; V _{GS} = 0 V; T _i = 25 °C	40	43	-	V
()	breakdown voltage	I _D = 250 μA; V _{GS} = 0 V; T _i = -40 °C	-	40.5	-	V
		I _D = 250 μA; V _{GS} = 0 V; T _j = -55 °C	36	40	-	V
00()	gate-source threshold voltage	I _D = 1 mA; V _{DS} =V _{GS} ; T _j = 25 °C; <u>Fig. 9;</u> Fig. 10	1.45	1.76	2.15	V
		I _D = 1 mA; V _{DS} =V _{GS} ; T _j = -55 °C; <u>Fig. 10</u>	-	-	2.6	V
		I _D = 1 mA; V _{DS} =V _{GS} ; T _j = 175 °C; Fig. 10	0.7	-	-	V
I _{DSS}	drain leakage current	V _{DS} = 40 V; V _{GS} = 0 V; T _j = 25 °C	-	0.02	1	μA
		V _{DS} = 16 V; V _{GS} = 0 V; T _j = 125 °C	-	0.7	10	μA
		V _{DS} = 40 V; V _{GS} = 0 V; T _j = 175 °C	-	70	500	μA
GSS	gate leakage current	V _{GS} = 20 V; V _{DS} = 0 V; T _j = 25 °C	-	43 - 40.5 - 40.5 - 40 - 1.76 2.15 - 2.6 - - 0.02 1 0.7 10 70 500 2 100 2 100 2 100 3.8 4.5 5.4 6.7 5.9 7.3 7 8.6 4.6 5.9 7 9.5 8.4 11.3 2 5.1 36 50 16 23 6.6 10 3.7 7.4 2512 3517 437 612 100 220 16 - 124 -	nA	
		V _{GS} = -20 V; V _{DS} = 0 V; T _j = 25 °C	-	2	100	nA
R _{DSon}	drain-source on-state resistance	V _{GS} = 10 V; I _D = 25 A; T _j = 25 °C; Fig. 11	2.7	3.8	4.5	mΩ
		V _{GS} = 10 V; I _D = 25 A; T _j = 105 °C; Fig. 12	3.6	5.4	6.7	mΩ
		V _{GS} = 10 V; I _D = 25 A; T _j = 125 °C; Fig. 12	3.9	5.9	7.3	mΩ
		V _{GS} = 10 V; I _D = 25 A; T _j = 175 °C; <u>Fig. 12</u>	4.6	7	8.6	mΩ
		V _{GS} = 4.5 V; I _D = 25 A; T _j = 25 °C; Fig. 11	3.2	4.6	5.9	mΩ
		V _{GS} = 4.5 V; I _D = 25 A; T _j = 105 °C; Fig. 12	4.3	6.5	8.7	mΩ
		V _{GS} = 4.5 V; I _D = 25 A; T _j = 125 °C; Fig. 12	4.7	7	9.5	mΩ
		V _{GS} = 4.5 V; I _D = 25 A; T _j = 175 °C; Fig. 12	5.5	8.4	11.3	mΩ
R _G	gate resistance	f = 1 MHz; T _j = 25 °C	0.8	2	5.1	Ω
Dynamic ch	naracteristics					
Q _{G(tot)}	total gate charge	$ I_D = 25 \text{ A}; V_{DS} = 20 \text{ V}; V_{GS} = 10 \text{ V}; \\ T_j = 25 \text{ °C}; \overline{\text{Fig. 13}}; \overline{\text{Fig. 14}} $	-	36	50	nC
		$I_D = 25 \text{ A}; V_{DS} = 20 \text{ V}; V_{GS} = 4.5 \text{ V};$	-	16	23	nC
Q _{GS}	gate-source charge	T _j = 25 °C; <u>Fig. 13</u> ; <u>Fig. 14</u>	-	6.6	10	nC
Q _{GD}	gate-drain charge		-	3.7	7.4	nC
C _{iss}	input capacitance	$V_{DS} = 25 \text{ V}; V_{GS} = 0 \text{ V}; \text{ f} = 1 \text{ MHz};$	-	2512	3517	pF
C _{oss}	output capacitance	T _j = 25 °C; <u>Fig. 15</u>	-	437	612	pF
C _{rss}	reverse transfer capacitance		-	100	220	pF
d(on)	turn-on delay time	$V_{DS} = 20 \text{ V}; \text{ R}_{L} = 0.8 \Omega; \text{ V}_{GS} = 4.5 \text{ V};$	-	16	-	ns
t _r	rise time	$R_{G(ext)} = 5 \Omega; T_j = 25 °C$	-	24	-	ns
t _{d(off)}	turn-off delay time		-	22	-	ns

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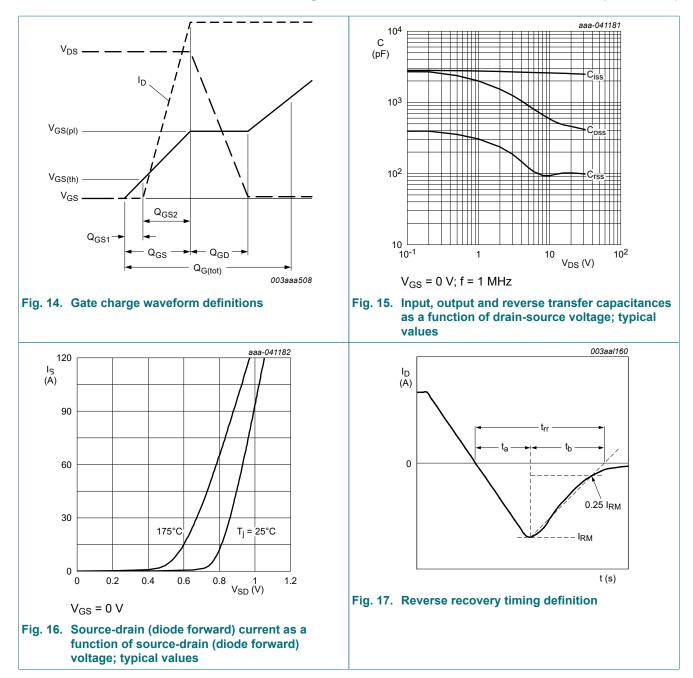
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
t _f	fall time			-	14	-	ns
Source-drain d	Source-drain diode						
V _{SD}	source-drain voltage	I_{S} = 25 A; V_{GS} = 0 V; T_{j} = 25 °C; <u>Fig. 16</u>		-	0.83	1.2	V
t _{rr}	reverse recovery time	I_{S} = 25 A; dI _S /dt = -100 A/µs; V _{GS} = 0 V;		-	23	-	ns
Q _r	recovered charge	V _{DS} = 20 V; T _j = 25 °C; <u>Fig. 17</u>	[1]	-	14	-	nC



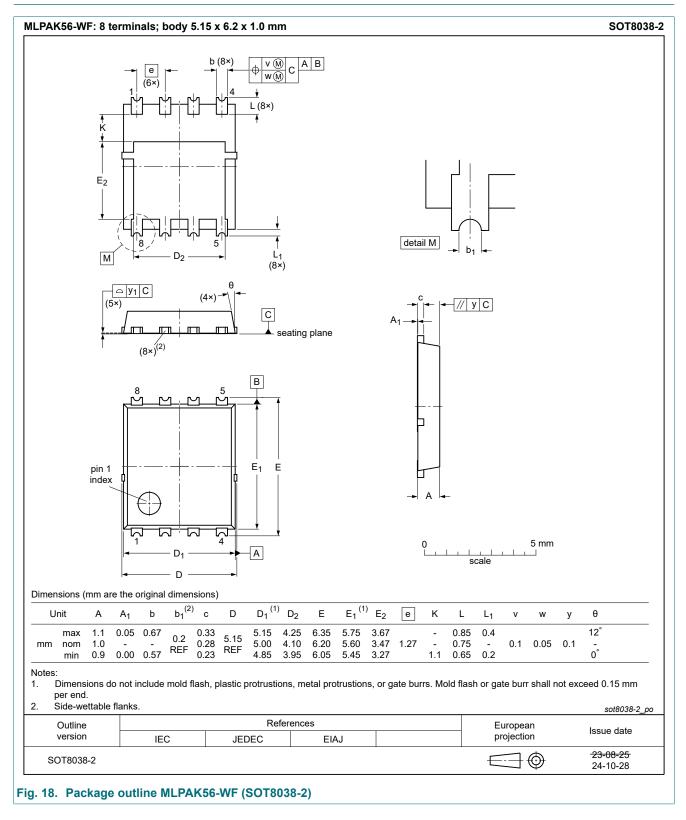




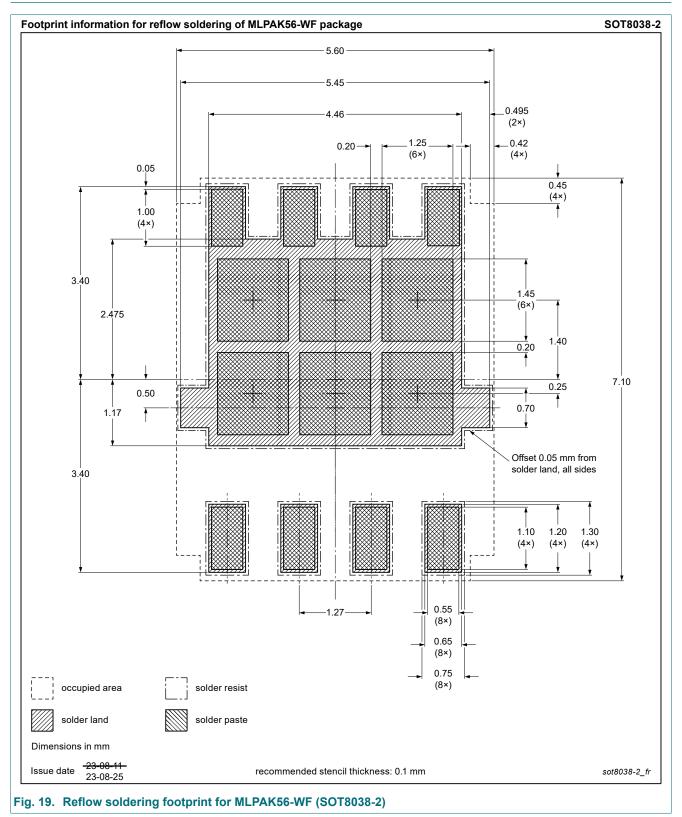
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11. Package outline



12. Soldering



13. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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[2] The term 'short data sheet' is explained in section "Definitions".

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